TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSII)

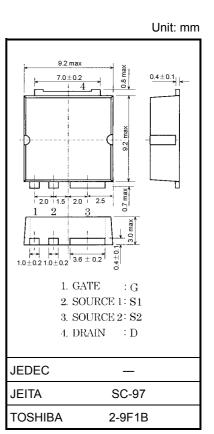
2SK3439

DC-DC Converter Relay Drive and Motor Drive Applications

- Low drain-source ON resistance: R_{DS} (ON) = 3.8 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 70 \text{ S} (typ.)$
- Low leakage current: $I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 30 \ V)$
- Enhancement-mode: V_{th} = 1.3 to 2.5 V (V_{DS} = 10 V, I_D = 1 mA)

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage			V _{DSS}	30	V
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)			V _{DGR}	30	V
Gate-source voltage			V _{GSS}	±20	V
Drain current	DC	(Note 1)	Ι _D	75	
	Pulse	(t≦1ms) (Note 1)	I _{DP}	300	A
Drain power dissipation (Tc = 25° C)			PD	125	W
Single pulse avalanche energy (Note 2)			E _{AS}	731	mJ
Avalanche current			I _{AR}	75	А
Repetitive avalanche energy (Note 3)			E _{AR}	12.5	mJ
Channel temperature			T _{ch}	150	°C
Storage temperature range			T _{stg}	-55 to 150	°C



Weight: 0.74 g (typ.)

flows into S2 pin.

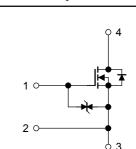
Notice:

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	1.00	°C/W

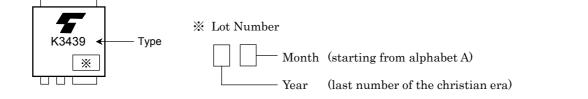
- Note 1: Please use devices on conditions that the channel temperature is below 150°C.
- Note 2: V_{DD} = 24 V, T_{ch} = 25 ^{\circ}C (initial), L = 100 $\mu H,$ R_G = 25 $\Omega,$ I_{AR} = 75 A
- Note 3: Repetitive rating; pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device. Please handle with caution.



Please use the S1 pin for gate input signal return. Make sure that the main current

Marking



Electrical Characteristics (Note 4) (Ta = 25°C)

Cha	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rent	I _{GSS}	$V_{GS}=\pm 16~V,~V_{DS}=0~V$	_	_	±10	μA
Drain cut-off curr	ent	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_	_	100	μA
Drain-source bre	akdown voltage	V (BR) DSS	$I_{D} = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	30	_		V
Gate threshold v	oltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	1.3	_	2.5	V
Daria a surra ON assistance		R _{DS (ON)}	V _{GS} = 10 V, I _D = 38 A	_	3.8	5.0	- mΩ
Drain-source ON	rain-source ON resistance		V _{GS} = 4 V, I _D = 38 A		5.0	10	
Forward transfer	admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 38 \text{ A}$	35	70		S
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		5450		pF
Reverse transfer capacitance		C _{rss}			620		
Output capacitance		C _{oss}			1850		
Switching time	Rise time	tr	$V_{GS} \stackrel{10}{}_{0 \text{ V}} \int I_{D} = 38 \text{ A}$ $V_{GS} \stackrel{10}{}_{0 \text{ V}} \int I_{D} = 38 \text{ A}$ $G \stackrel{\circ}{}_{0 \text{ V}} \stackrel{\circ}{}_{0 $	_	15		ns
	Turn-on time	t _{on}		_	30		
	Fall time	t _f		_	65		
	Turn-off time	t _{off}			110	_	
Total gate charge (gate-source plus gate-drain)		Qg			116	_	nC
Gate-source charge		Q _{gs}	V _{DD} ≈ 34 V, V _{GS} = 10 V, I _D = 75 A		84		
Gate-drain ("miller") charge		Q _{gd}	1	_	32		

Note 4: Please connect the S1 pin and S2 pin, and then ground the connected pin. (However, while switching times are measured, please don't connect and ground it.)

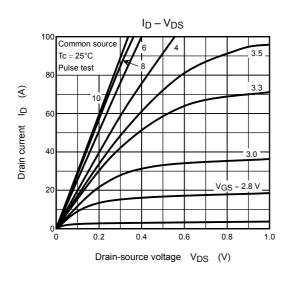
Source-Drain Ratings and Characteristics (Note 5) (Ta = 25°C)

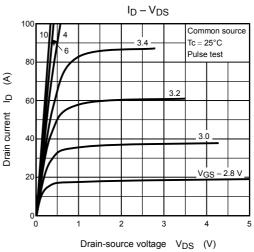
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1, Note 5)	I _{DR} 1	—		_	75	А
Pulse drain reverse current (Note 1, Note 5)	I _{DRP} 1	—		_	300	А
Continuous drain reverse current (Note 1, Note 5)	I _{DR} 2	—		_	1	А
Pulse drain reverse current (Note 1, Note 5)	I _{DRP} 2	—		_	4	А
Forward voltage (diode)	V _{DS2F}	I _{DR} 1 = 75 A, V _{GS} = 0 V	_		-1.5	V
Reverse recovery time	t _{rr}	$I_{DR} = 75 \text{ A}, V_{GS} = 0 \text{ V},$	_	120		ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 50 A/μs		180		nC

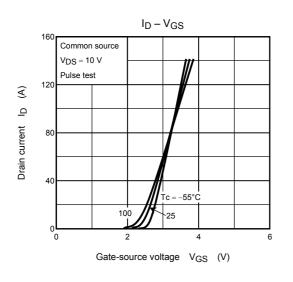
Note 5: drain, flowing current value between the S2 pin, open the S1 pin drain, flowing current value between the S1 pin, open the S2 pin

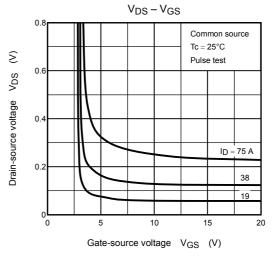
Unless otherwise specified, please connect the S1 and S2 pins, and then ground the connected pin.

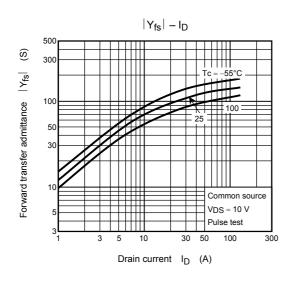
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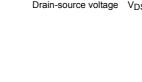






 $R_{DS} (ON) - I_{D}$

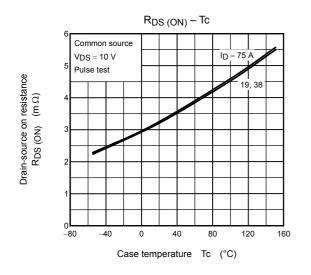


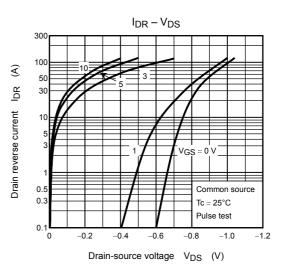


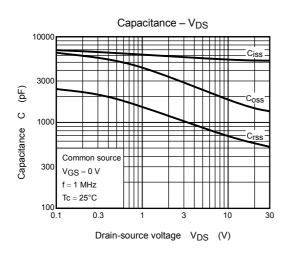
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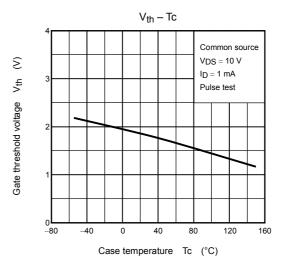
Drain-source on resistance RDS (ON) (mΩ)

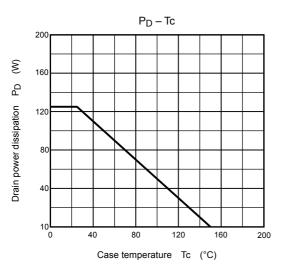
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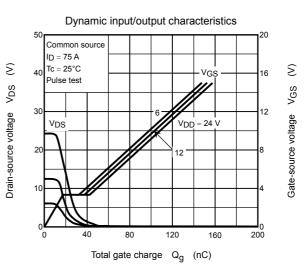




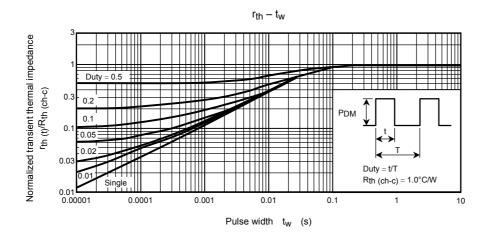


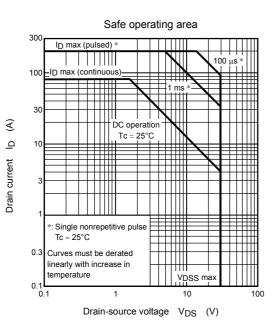


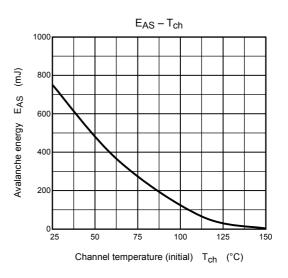


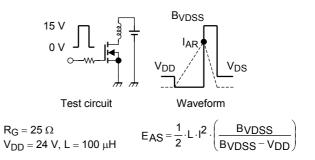


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